

Press Release Baar, 09 December 2010

Meyer Burger wins order for over CHF 40 million with a new customer in Asia

Meyer Burger has successfully concluded a contract of over CHF 40 million with a new customer in Asia. The contract includes slicing, bricking, and automated gluing systems. The equipment is scheduled to be delivered during 2011.

Meyer Burger Technology Ltd (SIX Swiss Exchange: MBTN) announced today that the group member MB Wafertec (Meyer Burger Ltd) has succeeded in concluding a contract for the supply of wire saws, bricking systems and automated gluing systems, with a new customer in Asia. The advanced manufacturing equipment from MB Wafertec will secure the production of high quality solar wafers and is scheduled to be delivered during 2011.

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About Meyer Burger Technology Ltd

www.meyerburger.com

Meyer Burger is a leading and globally active technology group for innovative systems and processes for cutting and handling crystalline and other high-grade materials.

The machines, competences and technologies of the different companies within the group are used in the solar industry (photovoltaics), semiconductor and optical industry. The thinnest wafers made from silicon, sapphire or other crystals are required in these three markets to manufacture solar modules, switching circuits or high-performance LEDs. The group's core competences are made up of a whole range of production processes, machines and systems that are used within the value chain in the manufacture of high quality wafers. Since the merger in January 2010 with 3S Industries Ltd, the worldwide leader in turnkey production lines and single equipment for the manufacturing of solar modules, the group also covers the entire value chain for solar module production and combines the key technologies of soldering, laminating and testing under one roof. Solar module manufacturers worldwide use the string soldering machines of Somont, the laminating lines of 3S and the testing technologies of Pasan, to produce solar modules whose performance, operating life and quality meet the highest demands. The group's comprehensive range of products includes a worldwide service network with wear and tear parts, consumables, re-grooving services, process know-how, servicing, after-sales service, training and other services. As a globally active company, the group is represented in Europe, Asia and North America in the respective key markets.

Meyer Burger has its headquarters and the production facility of MB Wafertec (Meyer Burger Ltd) in Switzerland, while the group companies, Meyer Burger Automation GmbH, Hennecke Systems GmbH and AMB Apparate + Maschinenbau GmbH have their headquarters and production facilities in Germany. Diamond Materials Tech, Inc. has its headquarters in Colorado Springs, CO, USA. The production facilities of 3S Modultec, 3S Photovoltaics and Pasan are also located in Switzerland, while Somont is located in Germany. Meyer Burger Group has also subsidiaries and own service centres in Germany, Norway, Spain, USA, China, Japan, Singapore, South Korea and Taiwan. In other important markets, the company relies on selected independent agents. The registered shares of Meyer Burger Technology Ltd are listed on the SIX Swiss Exchange (Ticker: MBTN).

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